



## General Description

The SJP30ND180 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a wide variety of applications.

## Features

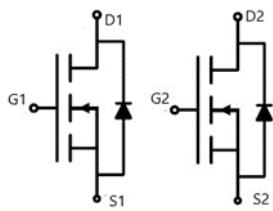
- Low Gate Charge
- High Power and current handing capability
- Lead free product is acquired

## Application

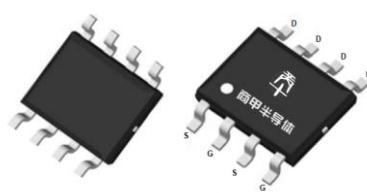
- PWM Applications
- Load Switch
- Power Management

## Key Performance Parametes

Parameter	Value	Unit
$V_{DS}$	30	V
$R_{DS(ON)}_{TYP}$	16.3	mΩ
$I_D$	7	A
$Q_G$	8	nC



Schematic Diagram



SOP-8 top&amp;bottom view

## Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJP30ND180	SJP30ND180	SOP-8	Tape	\	\	4000 Pcs

Table 1. Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Limit	Unit
$V_{DS}$	Drain-Source Voltage ( $V_{GS}=0\text{V}$ )	30	V
$V_{GS}$	Gate-Source Voltage ( $V_{DS}=0\text{V}$ )	$\pm 20$	V
$I_D$	Drain Current-Continuous( $T_A=25^\circ\text{C}$ )	7	A
	Drain Current-Continuous( $T_A=100^\circ\text{C}$ )	4.9	A
$I_{DM}$ (pulse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	28	A
$P_D$	Maximum Power Dissipation( $T_A=25^\circ\text{C}$ )	1.54	W
	Maximum Power Dissipation( $T_A=100^\circ\text{C}$ )	0.62	W
$E_{AS}$	Avalanche energy (Note 2)	30	mJ
$T_J$ , $T_{STG}$	Operating Junction and Storage Temperature Range	-55 To 150	°C

Table 2. Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		81	°C/W



## 30V N-Channel Trench Power MOSFET

Table 3. Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>On/Off States</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ , $I_{\text{D}}=250\mu\text{A}$	30			V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}=30\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=25^\circ\text{C}$			1	$\mu\text{A}$
		$V_{\text{DS}}=30\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=125^\circ\text{C}$			100	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$ , $V_{\text{DS}}=0\text{V}$			$\pm 100$	nA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$ , $I_{\text{D}}=250\mu\text{A}$	1		2.5	V
$g_{\text{FS}}$	Forward Transconductance	$V_{\text{DS}}=5\text{V}$ , $I_{\text{D}}=5\text{A}$		9.8		S
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance	$V_{\text{GS}}=10\text{V}$ , $I_{\text{D}}=5\text{A}$ , $T_J=25^\circ\text{C}$		16.3	20.4	$\text{m}\Omega$
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance	$V_{\text{GS}}=4.5\text{V}$ , $I_{\text{D}}=4\text{A}$ , $T_J=25^\circ\text{C}$		25.7	34.2	$\text{m}\Omega$
<b>Dynamic Characteristics</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=15\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1.0\text{MHz}$		445		pF
$C_{\text{oss}}$	Output Capacitance			59		pF
$C_{\text{rss}}$	Reverse Transfer Capacitance			45		pF
$R_g$	Gate resistance	$V_{\text{GS}}=0\text{V}$ , $V_{\text{DS}}=0\text{V}$ , $f=1.0\text{MHz}$		0.73		$\Omega$
<b>Switching Parameters</b>						
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{GS}}=4.5\text{V}$ , $V_{\text{DS}}=15\text{V}$ , $R_L=7.5\Omega$ , $R_{\text{GEN}}=3\Omega$		5		nS
$t_r$	Turn-on Rise Time			12		nS
$t_{\text{d(off)}}$	Turn-Off Delay Time			24		nS
$t_f$	Turn-Off Fall Time			2		nS
$Q_g$	Total Gate Charge	$V_{\text{GS}}=4.5\text{V}$ , $V_{\text{DS}}=15\text{V}$ , $I_{\text{D}}=2\text{A}$		8		nC
$Q_{\text{gs}}$	Gate-Source Charge			1.1		nC
$Q_{\text{gd}}$	Gate-Drain Charge			1.4		nC
<b>Source-Drain Diode Characteristics</b>						
$I_{\text{SD}}$	Source-Drain Current (Body Diode)				7	A
$V_{\text{SD}}$	Forward on Voltage (Note 3)	$V_{\text{GS}}=0\text{V}$ , $I_{\text{S}}=2\text{A}$			1.2	V
$t_{\text{rr}}$	Reverse Recovery Time	$I_F=2\text{A}$ , $dI/dt=500\text{A}/\mu\text{s}$		8.5		ns
$Q_{\text{rr}}$	Reverse Recovery Charge	$I_F=2\text{A}$ , $dI/dt=500\text{A}/\mu\text{s}$		3.4		nC

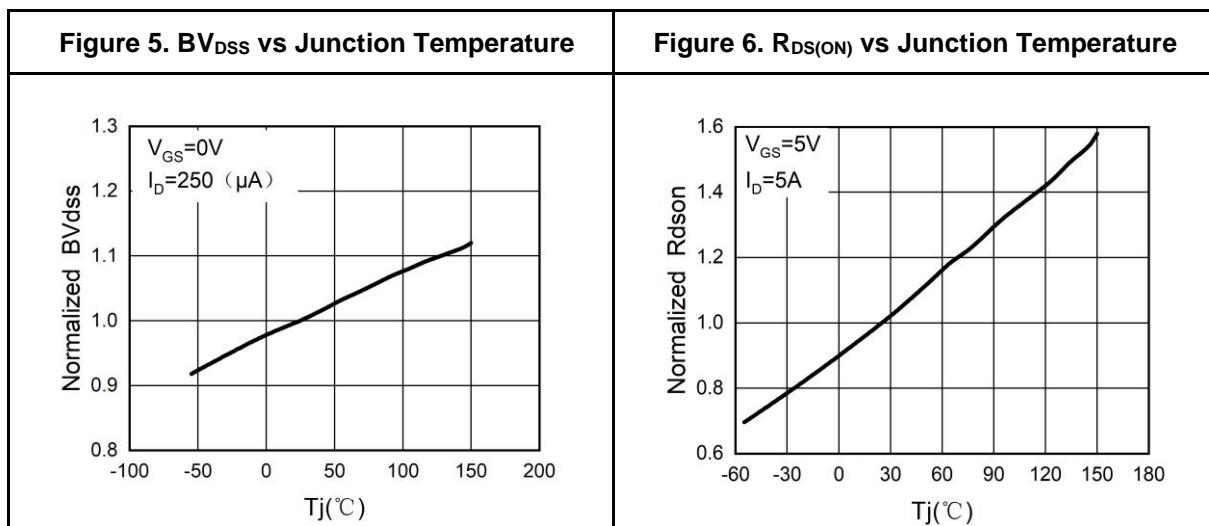
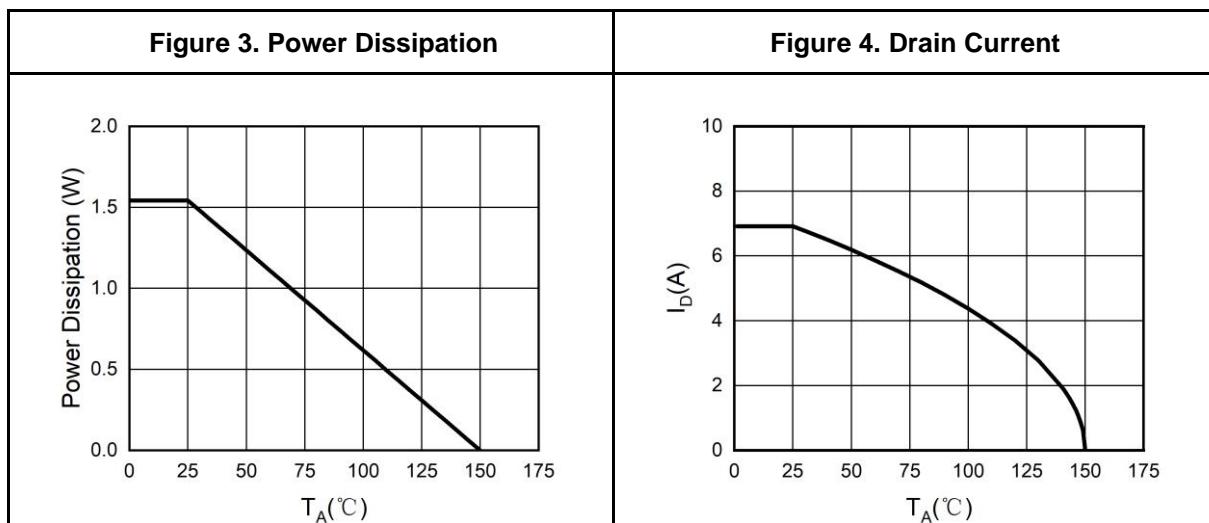
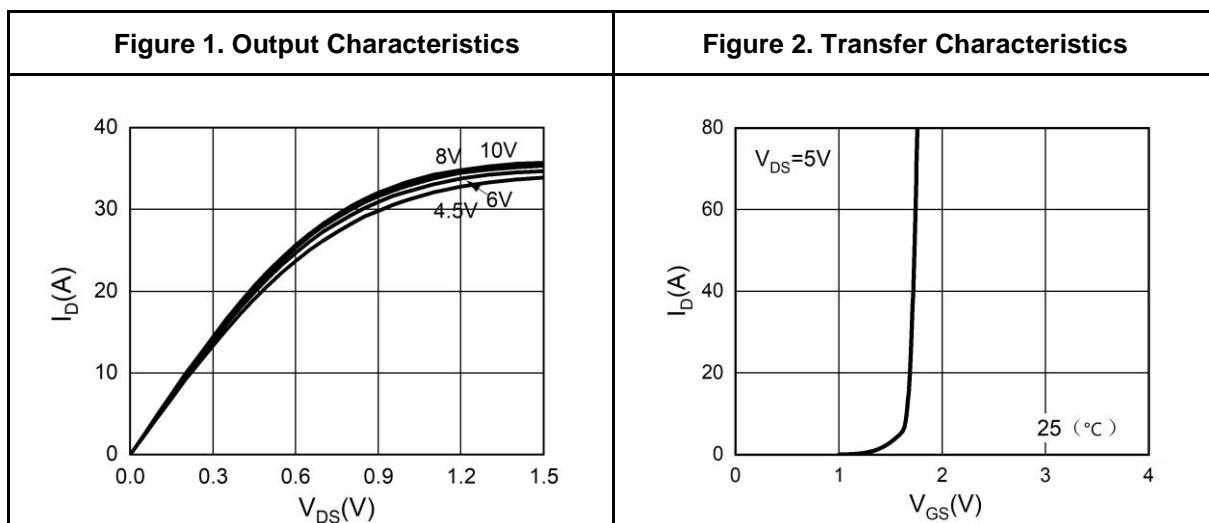
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

Notes 2.E<sub>AS</sub> condition:  $T_J=25^\circ\text{C}$ ,  $V_{\text{DD}}=30\text{V}$ ,  $V_G=10\text{V}$ ,  $R_g=25\Omega$ ,  $L=0.5\text{mH}$ .

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.



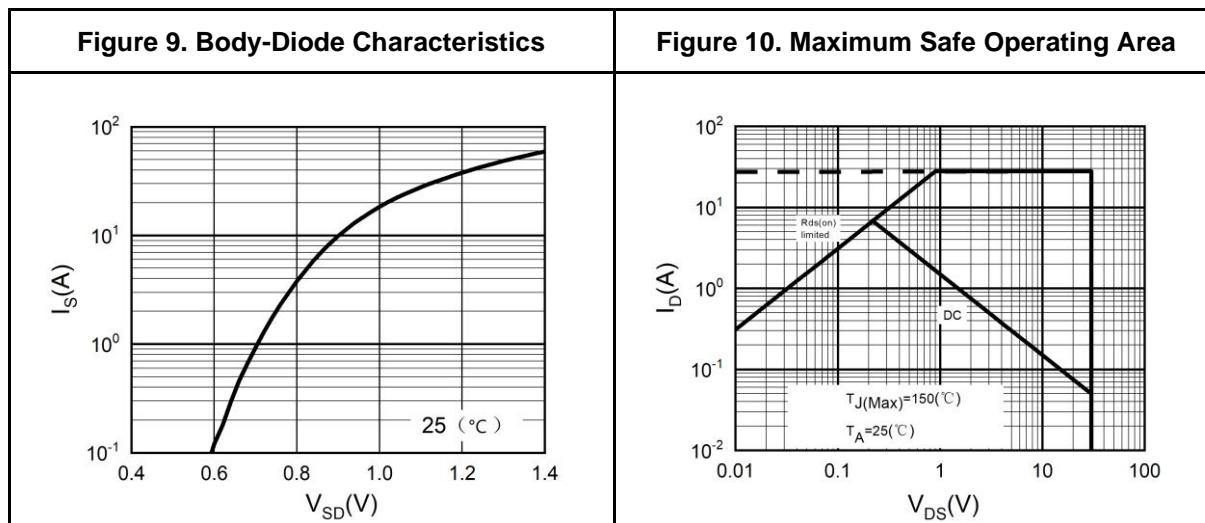
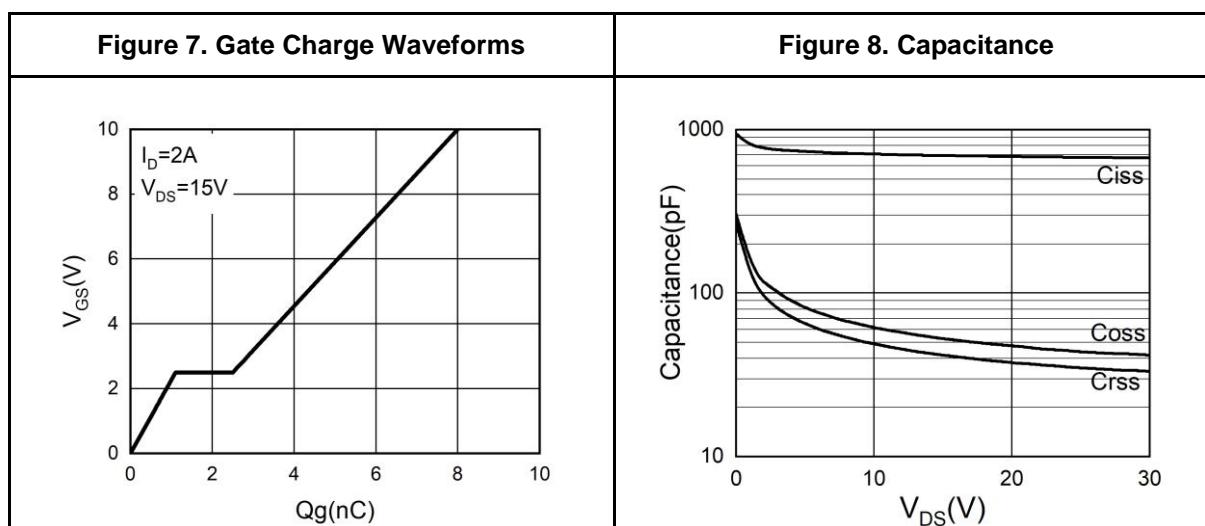
## Typical Electrical And Thermal Characteristics (Curves)





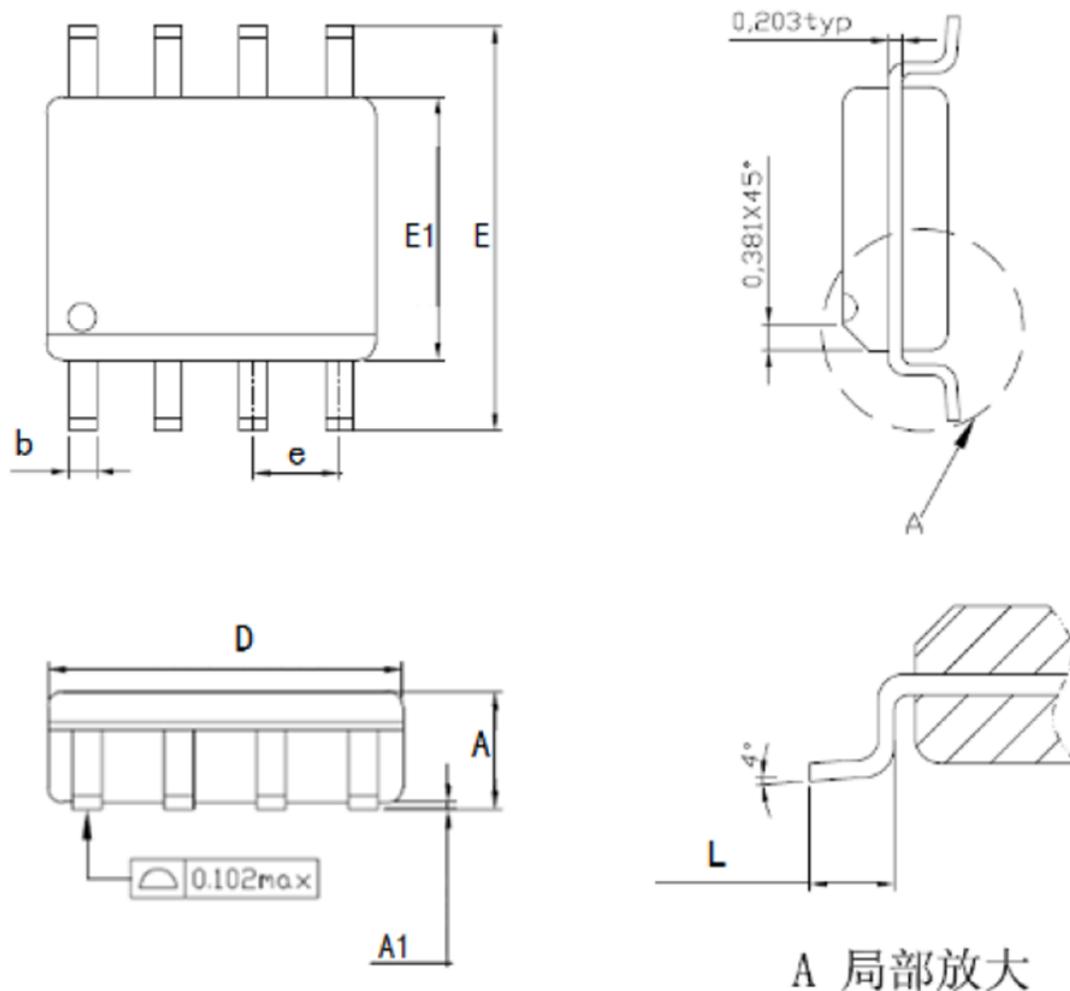
## 30V N-Channel Trench Power MOSFET

## Typical Electrical And Thermal Characteristics (Curves)





### SOP-8 Package Information



A 局部放大

Symbol	Dimensions In Millimeters		
	Min.	Nom.	Max
A	1.35	1.55	1.75
A1	0.1	0.15	0.2
b	0.346	0.406	0.466
D	4.8	4.89	4.98
E	5.75	6.00	6.25
E1	3.81	3.90	3.99
e	1.27TYP		
L	0.406	0.838	1.27



## Attention

This product described in this document can not be used in life support devices or systems, aircraft's control systems, and other applications whose failure can be reasonably expected to result in serious physical and/or material damage, apart from that when an application agreement is signed between customer and Wuxi Shangjia Semiconductor.

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